



Dual N-Channel 30-V (D-S) MOSFET with Schottky Diode

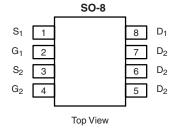
| PRODUCT SUMMARY | | | | | | | |
|-----------------|---------------------|------------------------------------|--------------------|--|--|--|--|
| | V _{DS} (V) | $R_{DS(on)}(\Omega)$ | I _D (A) | | | | |
| Channel-1 | _ 30 | 0.022 at $V_{GS} = 10 \text{ V}$ | 6.3 | | | | |
| | | 0.030 at V _{GS} = 4.5 V | 5.4 | | | | |
| Channel-2 | | 0.0155 at V _{GS} = 10 V | 9.5 | | | | |
| | | 0.0205 at V _{GS} = 4.5 V | 8.2 | | | | |

| SCHOTTKY PRODUCT SUMMARY | | | | | | |
|--------------------------|--|--------------------|--|--|--|--|
| V _{DS} (V) | V _{SD} (V) Diode Forward Voltage | I _F (A) | | | | |
| 30 | 0.50 V at 1.0 A | 2.0 | | | | |

FEATURES

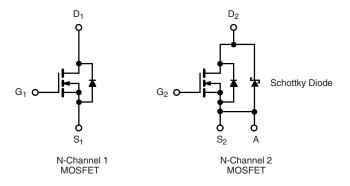
- Halogen-free According to IEC 61249-2-21 Definition
- LITTLE FOOT[®] Plus
- Compliant to RoHS directive 2002/95/EC





Ordering Information: Si4818DY-T1-E3 (Lead (Pb)-free)

Si4818DY-T1-GE3 (Lead (Pb)-free and Halogen-free)



| ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted | | | | | | | | | |
|---|-----------------------------------|------------------|--------------|------|--------------|------|---|--|--|
| | | | Channel-1 | | Ch | | | | |
| Parameter | Symbol | 10 s | Steady State | 10 s | Steady State | Unit | | | |
| Drain-Source Voltage | V_{DS} | 30 | | | | V | | | |
| Gate-Source Voltage | V _{GS} | 20 | | | | | | | |
| Continuous Drain Current (T _J = 150 °C) ^a | T _A = 25 °C | - I _D | 6.3 | 5.3 | 9.5 | 7.0 | | | |
| | T _A = 70 °C | | 5.4 | 4.2 | 7.6 | 5.6 | | | |
| Pulsed Drain Current | | I _{DM} | | 30 | 40 | | Α | | |
| Continuous Source Current (Diode Conduction) ^a | | I _S | 1.3 | 0.9 | 2.2 | 1.15 | | | |
| Maximum Power Dissipation ^a | T _A = 25 °C | P _D | 1.4 | 1.0 | 2.4 | 1.25 | W | | |
| | T _A = 70 °C | | 0.9 | 0.64 | 1.5 | 0.80 | | | |
| Operating Junction and Storage Temperature | T _J , T _{stg} | - 55 to 150 | | | | ô | | | |

| THERMAL RESISTANCE RATINGS | | | | | | | | | | |
|--|--------------|-------------------|------|-----------|------|----------|------|------|------|--|
| | | Channel-1 | | Channel-2 | | Schottky | | | | |
| Parameter | | Symbol | Тур. | Max. | Тур. | Max. | Тур. | Max. | Unit | |
| Maximum Junction-to-Ambient ^a | t ≤ 10 s | R _{thJA} | 72 | 90 | 43 | 53 | 48 | 60 | | |
| Maximum Junction-to-Ambient | Steady State | ' 'thJA | 100 | 125 | 82 | 100 | 80 | 100 | °C/W | |
| Maximum Junction-to-Foot (Drain) | Steady State | R _{thJC} | 51 | 63 | 25 | 30 | 28 | 35 | | |

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

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| MOSFET SPECIFICATION | | | | | | 1 | | |
|---|---------------------|--|------|------|-------------------|--------|------|--|
| Parameter | Symbol | Test Conditions | | Min. | Typ. ^a | Max. | Unit | |
| Static | | | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | Ch-1 | 0.8 | | | V | |
| - Calle Timesheld Tellage | G3(III) | D3 | Ch-2 | 1.0 | | | | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = 20 \text{ V}$ | Ch-1 | | | 100 | nA | |
| | 400 | | Ch-2 | | | 100 | | |
| | | $V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$ | Ch-1 | | | 1 | | |
| Zero Gate Voltage Drain Current | I _{DSS} | | Ch-2 | | | 100 | μΑ | |
| - | | $V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 85 ^{\circ}\text{C}$ | Ch-1 | | | 15 | | |
| | | | Ch-2 | | | 2000 | | |
| On-State Drain Current ^b | $I_{D(on)}$ | $V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$ | Ch-1 | 20 | | | Α | |
| | , , | V 10 V 1 0 0 A | Ch-2 | 30 | 0.010 | 0.000 | | |
| | - | $V_{GS} = 10 \text{ V}, I_D = 6.3 \text{ A}$ | Ch-1 | | 0.018 | 0.022 | | |
| Drain-Source On-State Resistance ^b | R _{DS(on)} | $V_{GS} = 10 \text{ V}, I_D = 9.5 \text{ A}$ | Ch-2 | | 0.0125 | 0.0155 | Ω | |
| | 20(0) | $V_{GS} = 4.5 \text{ V}, I_D = 5.4 \text{ A}$ | Ch-1 | | 0.024 | 0.030 | | |
| | | $V_{GS} = 4.5 \text{ V}, I_D = 8.2 \text{ A}$ | Ch-2 | | 0.0165 | 0.0205 | | |
| Forward Transconductance ^b | 9 _{fs} | $V_{DS} = 15 \text{ V}, I_{D} = 6.3 \text{ A}$ | Ch-1 | | 17 | | s | |
| Torward Transconductance | 915 | $V_{DS} = 15 \text{ V}, I_{D} = 9.5 \text{ A}$ | Ch-2 | | 28 | |) | |
| Diode Forward Voltage ^b | V _{SD} | I _S = 1.3 A, V _{GS} = 0 V | Ch-1 | | 0.7 | 1.1 | V | |
| | | $I_S = 1 A, V_{GS} = 0 V$ | Ch-2 | | 0.47 | 0.5 | | |
| Dynamic ^a | | | | | | | | |
| Total Gate Charge | Q _q | Charmal 4 | Ch-1 | | 8.0 | 12 | | |
| Total Gate Charge | ₹g | Channel-1 $V_{DS} = 15 \text{ V}, V_{GS} = 5 \text{ V}, I_{D} = 6.3 \text{ A}$ | Ch-2 | | 15 | 23 | • | |
| Gate-Source Charge | Q_{gs} | V _{DS} = 15 V, V _{GS} = 5 V, I _D = 0.5 A | Ch-1 | | 1.75 | | nC | |
| Gate-Source Charge | ₩gs | Channel-2 | Ch-2 | | 5.3 | | 110 | |
| Gate-Drain Charge | Q _{ad} | $V_{DS} = 15 \text{ V}, V_{GS} = 5 \text{ V}, I_{D} = -9.5 \text{ A}$ | Ch-1 | | 3.2 | | - | |
| Gate-Drain Charge | €gd | | Ch-2 | | 4.6 | | | |
| Gate Resistance | R _q | | Ch-1 | 1.5 | | 6.1 | 0 | |
| date nesistance | ' 'g | | Ch-2 | 0.5 | | 2.6 | Ω | |
| Turn On Doloy Time | +. | | Ch-1 | | 10 | 20 | | |
| Turn-On Delay Time | t _{d(on)} | Channel-1 | Ch-2 | | 15 | 30 | | |
| Diag Time | + | $V_{DD} = 15 \text{ V}, R_L = 15 \Omega$ | Ch-1 | | 5 | 10 | | |
| Rise Time | t _r | $I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 6 \Omega$ | Ch-2 | | 5 | 10 | | |
| Turn-Off Delay Time | t _{d(off)} | Channel-2 V_{DD} = 15 V, R_L = 15 Ω | Ch-1 | | 26 | 50 | | |
| | | | Ch-2 | | 44 | 80 | ns | |
| Fall Time | | $I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_q = 6 \Omega$ | Ch-1 | | 8 | 16 | | |
| | t _f | .D = . / 1, *GEN = 10 *, 11g = 0 22 | Ch-2 | | 12 | 24 | | |
| 0 0 0 0 | | I _F = 1.3 A, dI/dt = 100 A/μs | Ch-1 | | 30 | 60 | | |
| Source-Drain Reverse Recovery Time | t _{rr} | I _F = 2.2 A, dI/dt = 100 μA/μs | Ch-2 | | 32 | 70 | | |

Notes

- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

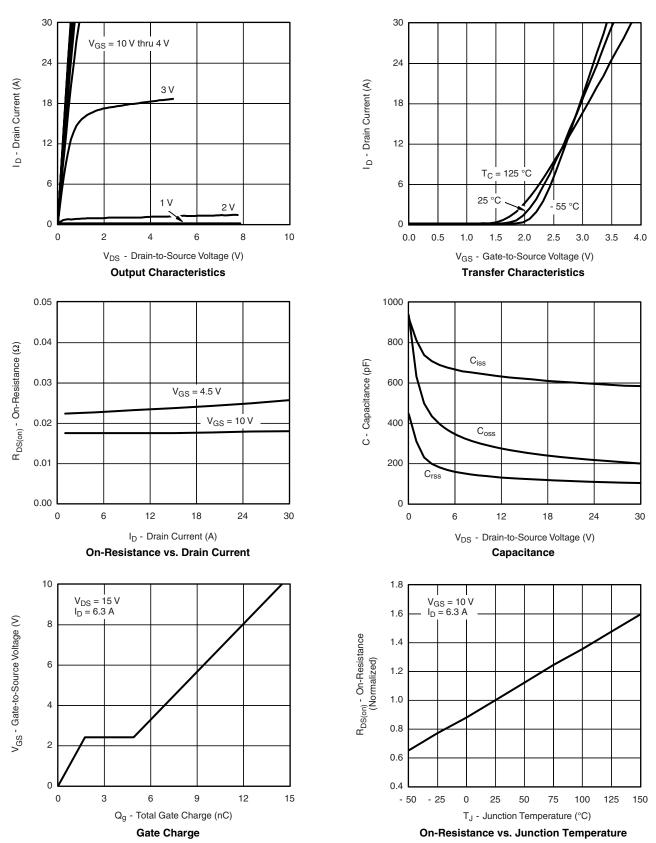
| SCHOTTKY SPECIFICATIONS $T_J = 25$ °C, unless otherwise noted | | | | | | | | | |
|---|-----------------|--|------|-------|-------|------|--|--|--|
| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | | | |
| Forward Voltage Drop | V _F | I _F = 1.0 A | | 0.47 | 0.50 | V | | | |
| | | I _F = 1.0 A, T _J = 125 °C | | 0.36 | 0.42 | | | | |
| Maximum Reverse Leakage Current | I _{rm} | V _R = 30 V | | 0.004 | 0.100 | | | | |
| | | V _R = 30 V, T _J = 100 °C | | 0.7 | 10 | mA | | | |
| | | V _R = - 30 V, T _J = 125 °C | | 3.0 | 20 | | | | |
| Junction Capacitance | C _T | V _R = 10 V | | 50 | | pF | | | |

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



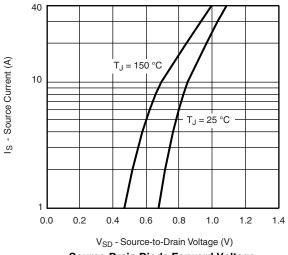


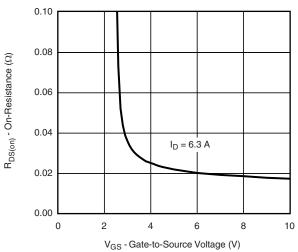
CHANNEL-1 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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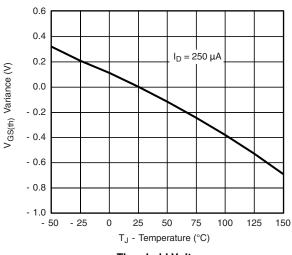
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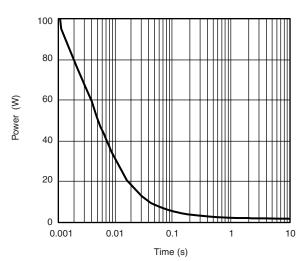




Source-Drain Diode Forward Voltage

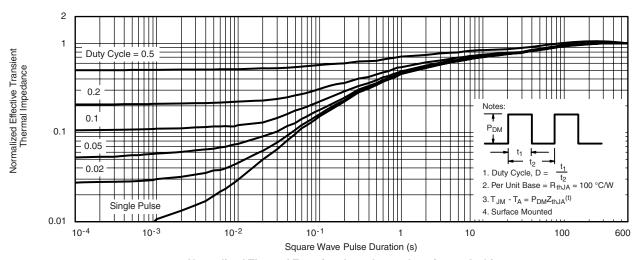






Threshold Voltage

Single Pulse Power, Junction-to-Ambient

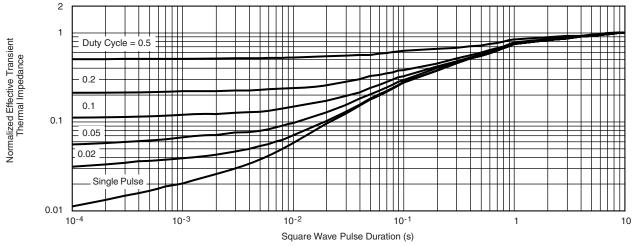


Normalized Thermal Transient Impedance, Junction-to-Ambient



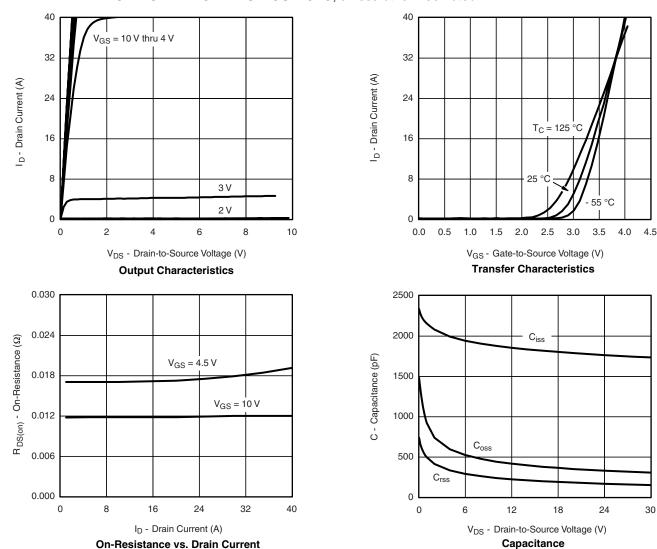


CHANNEL-1 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

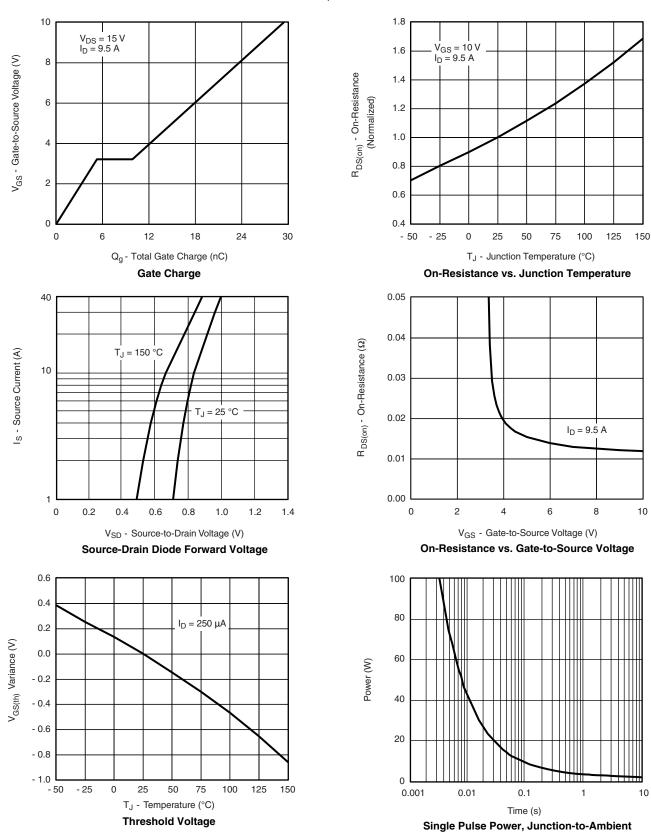
CHANNEL-2 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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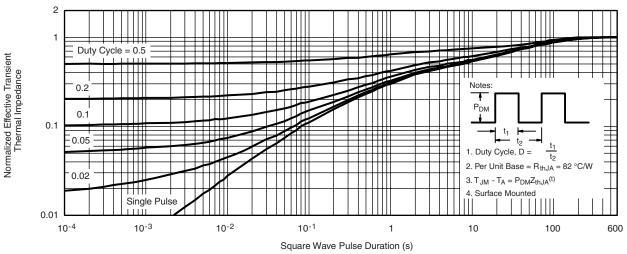
CHANNEL-2 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



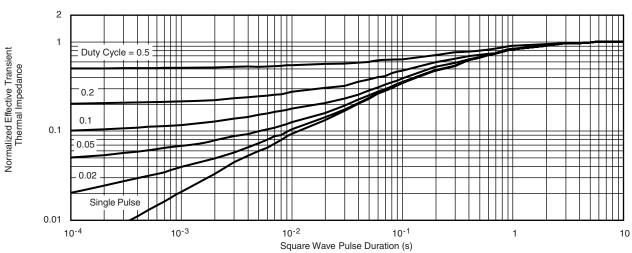




CHANNEL-2 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



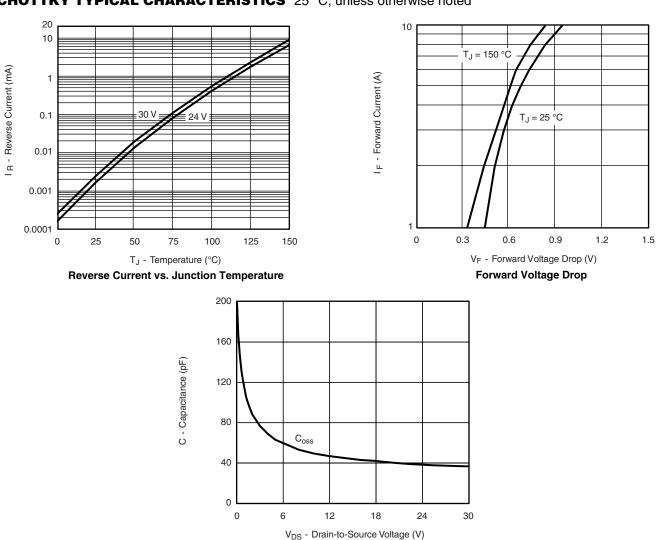
Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot



SCHOTTKY TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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